LTCC SURFACE MOUNT

Band Pass Filter

BFCN-1052+

50Ω 9700 to 11950 MHz

THE BIG DEAL

- Small Size, 3.2 × 1.6 mm
- Low Loss In Passband, 1.5 dB Typ. Over 9700 to 11950 MHz
- Very High Rejection Over Wide Band
- Temperature Stable
- Hermetically Sealed
- LTCC Construction



Generic photo used for illustration purposes only

CASE STYLE: FV1206-9

+RoHS Compliant
The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- Harmonic Rejection
- Transmitters / Receivers
- Test and Measurement

PRODUCT OVERVIEW

Mini-Circuits' BFCN-1052+ LTCC band pass filter achieves a miniature size and high repeatability of performance. Wrap-around terminations minimize variations in performance due to parasitics. Passing 9700 to 11950 MHz, these units offer excellent rejection over a wide stop band.

KEY FEATURES

Features	Advantages
Small Size, 3.2 × 1.6 mm	Allows for high layout density of circuit boards, while minimizing effects of parasitics.
Rejection Peaks Close to Passband	Provides good rejection of signals close to the passband, for improved system performance.
Wide Stop Band	Reduced regrowth at 2nd harmonic permits filter to be used in presence of wideband undesired signals.
LTCC Construction	Provides a rugged package that is well suited for tough environments including high humidity and high temperature extremes.

REV. A
ECO-030938
BFCN-1052+
MCL NY
260914

Band Pass Filter

BFCN-1052+

50Ω 9700 to 11950 MHz

ELECTRICAL SPECIFICATIONS[1,2] AT +25 °C

Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Units
Passband	Center Frequency	-	-	-	10770	-	MHz
	Insertion Loss	F1–F2	9700–11950	-	1.6	3.0	dB
	VSWR	F1–F2	9700–11950	-	1.9	-	:1
Stop Band, Lower	Insertion Loss	DC–F3	DC–8100	30	38	-	dB
		-	8100–8400	20	32	-	
Stop Band, Upper	Insertion Loss	F4–F5	14000–28500	20	28	-	dB
		F5–F6	28500–44000	-	25	-	

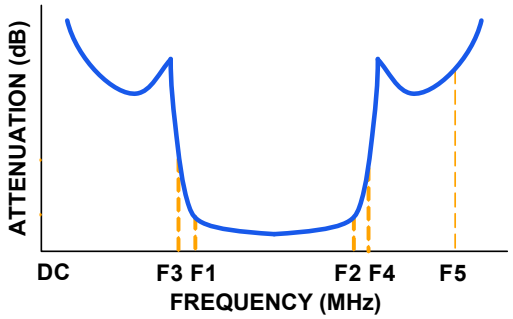
1. Measured on Mini-Circuits Characterization Test Board TB-BFCN-1052+ with feedline losses removed by normalization of S12 and S21 traces to measurement of TB thru-line.
2. This filter can not be used as a DC Blocking circuit element. In Applications where DC voltage is present at either input or output ports, blocking capacitors are required at the corresponding RF port.

ABSOLUTE MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-55 °C to +100 °C
Storage Temperature	-55 °C to +100 °C
RF Power Input[3]	2 W at +25 °C

3. Pass band rating, derate linearly to 0.5 W at +100 °C ambient.
Permanent damage may occur if any of these limits are exceeded.

TYPICAL FREQUENCY RESPONSE



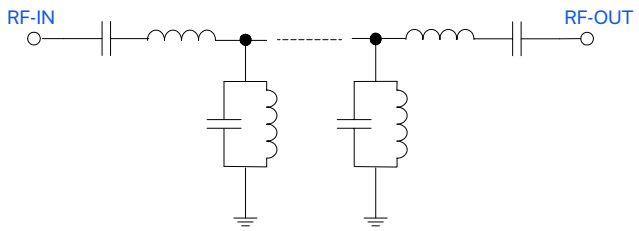
LTCC SURFACE MOUNT

Band Pass Filter

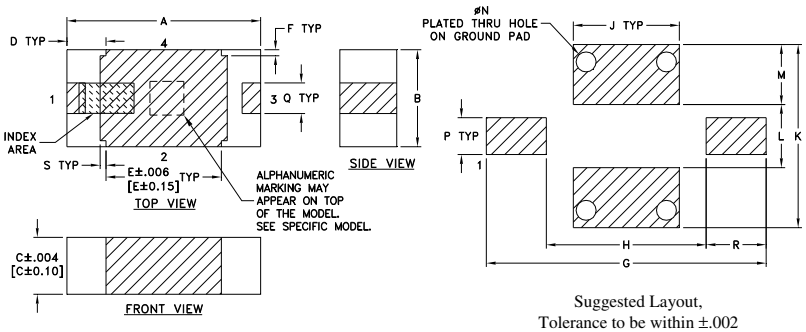
BFCN-1052+

50Ω 9700 to 11950 MHz

FUNCTIONAL SCHEMATIC



CASE STYLE DRAWING



Suggested Layout,
Tolerance to be within ±.002

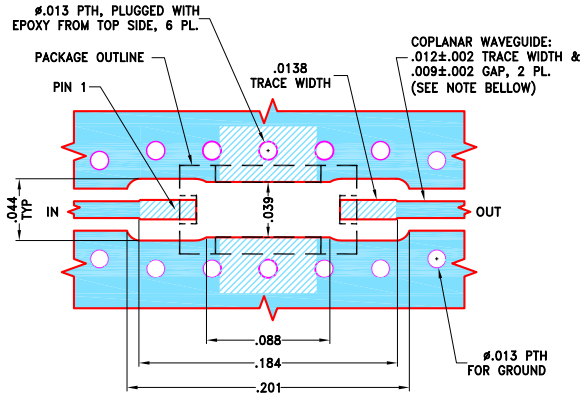
PIN CONNECTIONS

RF-IN	1
RF-OUT	3
GROUND	2

PRODUCT MARKING: KL

DEMO BOARD P/N: TB-BFCN-1052+

SUGGESTED PCB LAYOUT (PL-610)



NOTES:
1. TRACE WIDTH AND GAP PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .0066"±.0007". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
3. UNIT LAND PATTERN WAS OPTIMIZED FOR BETTER PERFORMANCE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

OUTLINE DIMENSIONS (Inches / mm)

A	B	C	D	E	F	G	H	J
.126	.063	.037	.026	.075	.004	.182	.104	.069
3.20	1.60	0.94	0.66	1.91	0.10	4.62	2.64	1.753

K	L	M	N	P	Q	R	S	wt
0.119	0.041	.039	.013	.024	.020	.039	.004	grams
3.023	1.041	0.99	0.33	0.61	0.51	0.99	0.10	.020

TAPE & REEL INFORMATION: F75

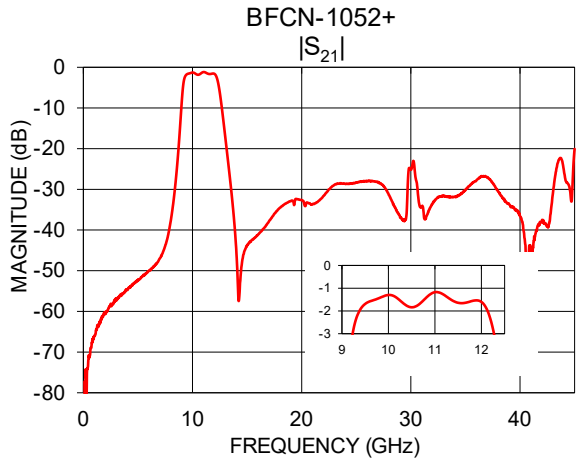
Band Pass Filter

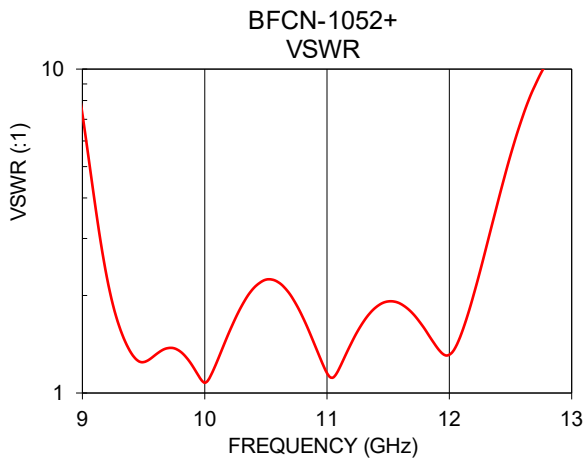
BFCN-1052+

50Ω 9700 to 11950 MHz

TYPICAL PERFORMANCE DATA AT +25 °C

Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)
1000	67.66	50.51
5000	53.39	26.26
8000	37.87	16.83
9000	12.22	7.04
10000	1.28	1.06
11000	1.38	1.63
12000	1.43	1.57
13000	13.21	5.03
15000	43.13	9.36
17000	37.34	11.85
20000	31.96	9.70
25000	28.59	6.41
35000	32.06	6.05
40000	40.15	5.17
41000	35.93	4.53





NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.

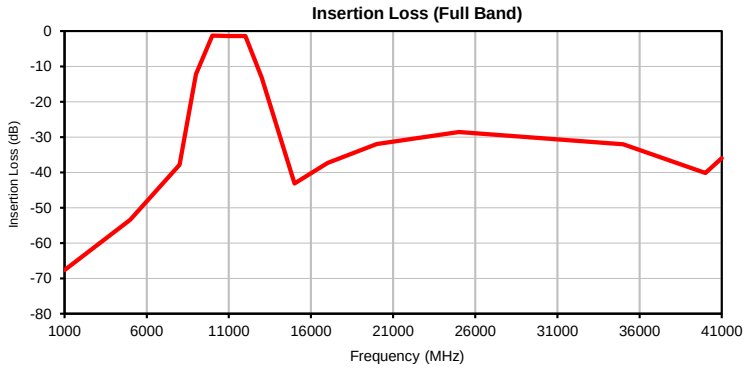
C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

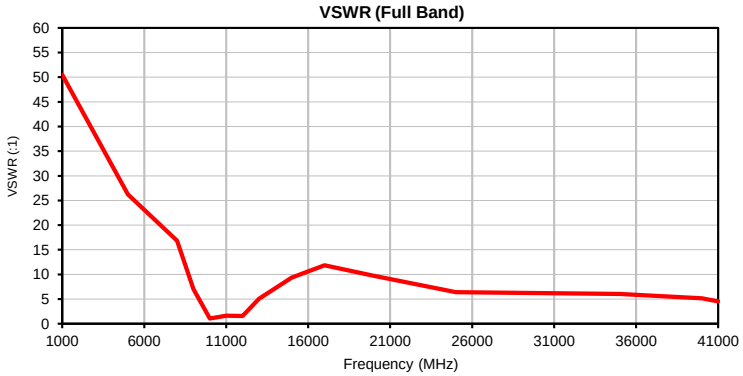
Ceramic Bandpass Filter BFCN-1052+

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	VSWR (:1)
1000	-67.66	50.51
5000	-53.39	26.26
8000	-37.87	16.83
9000	-12.22	7.04
10000	-1.28	1.06
11000	-1.38	1.63
12000	-1.43	1.57
13000	-13.21	5.03
15000	-43.13	9.36
17000	-37.34	11.85
20000	-31.96	9.70
25000	-28.59	6.41
35000	-32.06	6.05
40000	-40.15	5.17
41000	-35.93	4.53

Typical Performance Curves

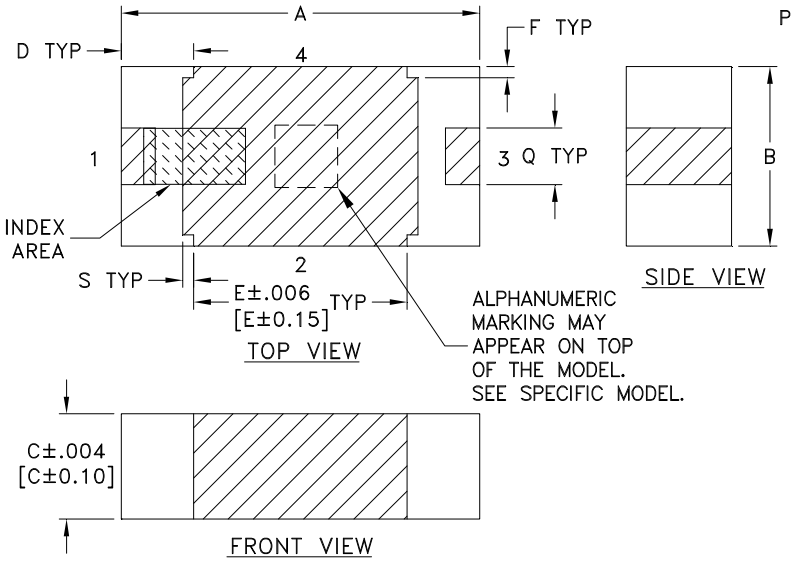




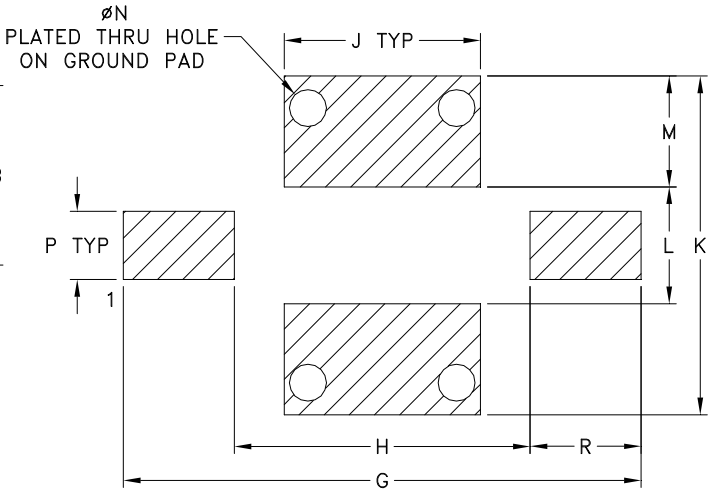
Case Style FV

FV1206-9

Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

CASE #	A	B	C	D	E	F	G	H	J	K	L	M
FV1206-9	.126 (3.20)	.063 (1.60)	.037 (0.94)	.026 (0.66)	.075 (1.91)	.004 (0.10)	.182 (4.62)	.104 (2.64)	.069 (1.75)	.119 (3.02)	.041 (1.04)	.039 (0.99)

CASE #	N	P	Q	R	S	WT. GRAM
FV1206-9	.013 (0.33)	.024 (0.61)	.020 (0.51)	.039 (0.99)	.004 (0.10)	.020

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

Notes:

1. Open style, ceramic base.
2. Termination finish: **as shown below or indicated on Data Sheet.**
   For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
   For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

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Tape & Reel Packaging TR-F75

DEVICE ORIENTATION IN T&R

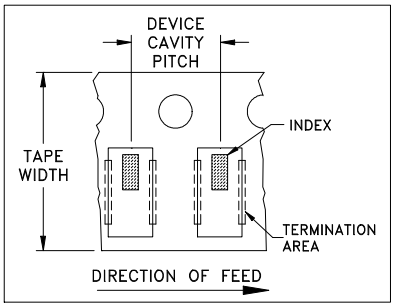


ILLUSTRATION 1

Applicable Case Styles
FV1206-1
FV1206-3

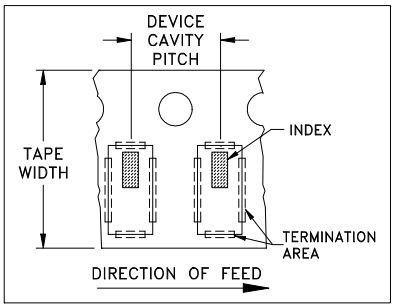


ILLUSTRATION 2

Applicable Case Styles
FV1206-4
FV1206-5
FV1206-6
FV1206-7
FV1206-9

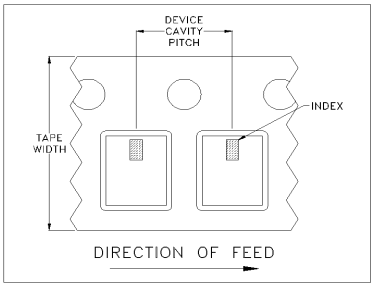


ILLUSTRATION 3

Applicable Case Styles
FV1206-11
FV1206-12
GE0805C-18
NL1008C-6
NL1008C-7
NL1008C-9
NL1008C-10
NL1008C-12

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	3000

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

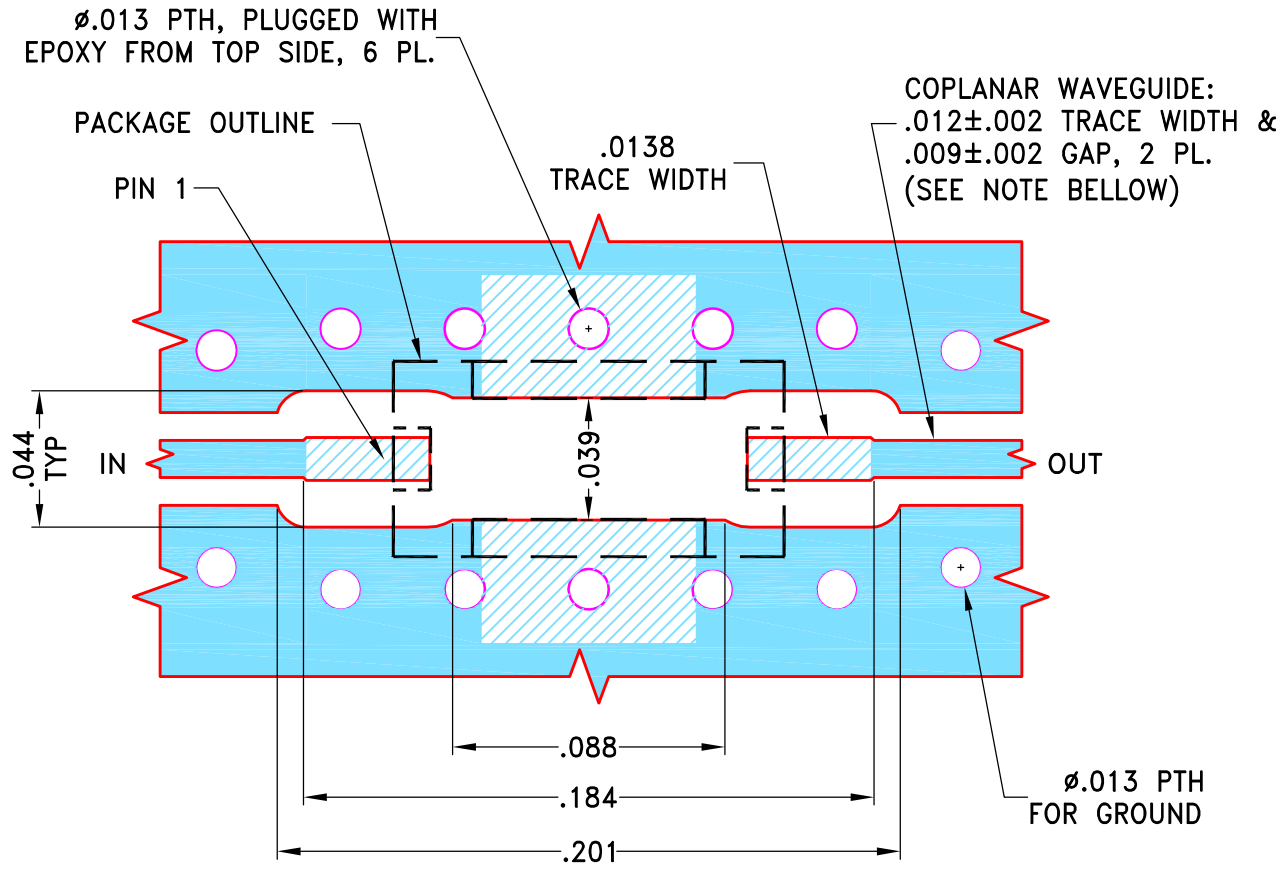
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THIRD ANGLE PROJECTION

REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M170506	NEW RELEASE	12/06/18	ITG	BK

SUGGESTED MOUNTING CONFIGURATION
FOR FV1206-9 CASE STYLE, "04FL01" PIN CODE



NOTES:

1. TRACE WIDTH AND GAP PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .0066"±.0007". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
3. UNIT LAND PATTERN WAS OPTIMIZED FOR BETTER PERFORMANCE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	ITG	12/05/18
TOLERANCES ON:	CHECKED	GF	12/05/18
2 PL DECIMALS ±	APPROVED	BK	12/06/18
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

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ASHEETA1.DWG REV:A DATE:01/12/95

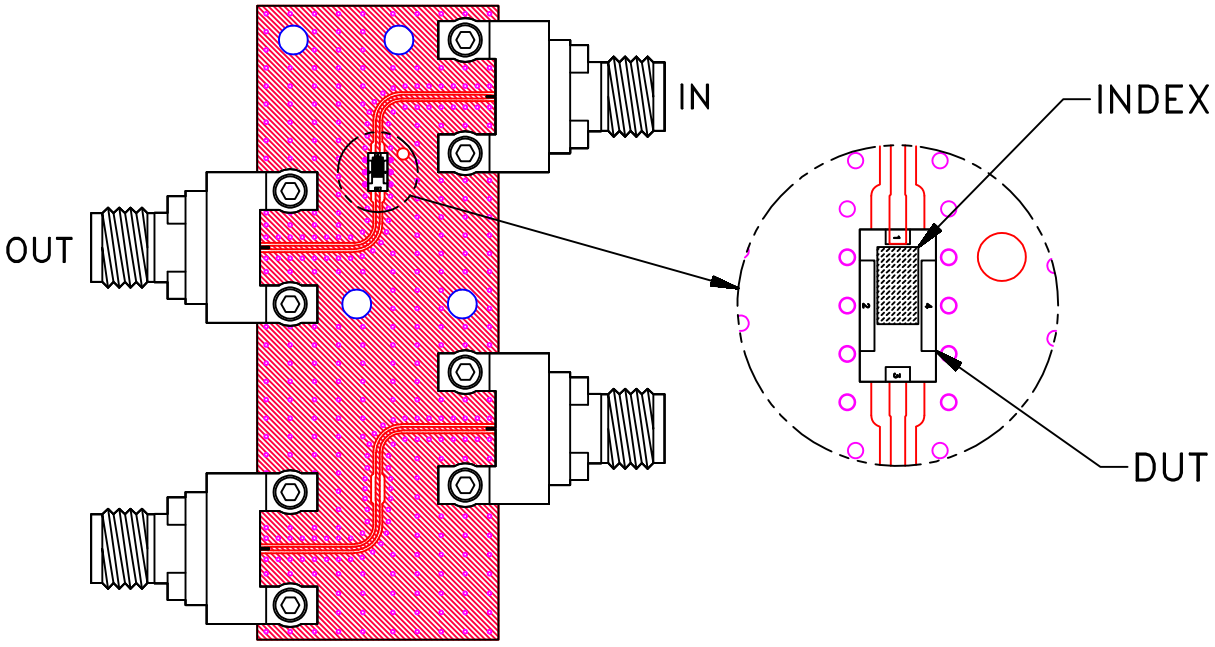
Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235

PL, 04FL01, FV1206-9, TB-1003+

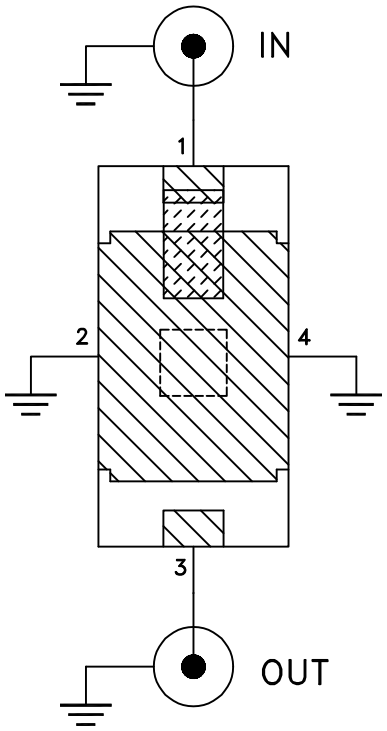
SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-610	OR

FILE:	SCALE:	SHEET:
98PL610	16:1	1 OF 1

Evaluation Board and Circuit



TB-1003+



Schematic Diagram

Notes:

1. 50 Ohm 2.92 mm Female connectors.
2. PCB Material: RO4350 or equivalent,
   Dielectric Constant=3.5, Thickness=.0066 inch.

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Mini-Circuits

Environmental Specifications ENV06

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A

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